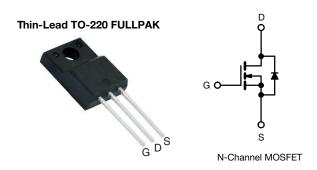


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HALOGEN

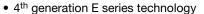
FREE

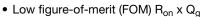
# **E Series Power MOSFET**

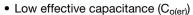


PRODUCT SUMMARY	,		
V <sub>DS</sub> (V) at T <sub>J</sub> max.	65	50	
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	V <sub>GS</sub> = 10 V	0.60	
Q <sub>g</sub> max. (nC)	1	2	
Q <sub>gs</sub> (nC)		3	
Q <sub>gd</sub> (nC)		3	
Configuration	Single		

#### **FEATURES**







· Reduced switching and conduction losses



 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

## **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Solar (PV inverters)

ORDERING INFORMATION	
Package	Thin-Lead TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHA690N60E-GE3

PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			$V_{DS}$	600	V
Gate-source voltage			$V_{GS}$	± 30	V
Continuous drain current (T <sub>.I</sub> = 150 °C) e	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	,	4.3	
Continuous drain current (1) = 150 C)	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 100 °C	I <sub>D</sub>	2.7	А
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	11	
Linear derating factor				0.23	W/°C
Single pulse avalanche energy b			E <sub>AS</sub>	9	mJ
Maximum power dissipation			$P_{D}$	29	W
Operating junction and storage temperature ra	nge		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope $T_J = 125 ^{\circ}\text{C}$		T <sub>J</sub> = 125 °C	-l / -l.	70	1//22
Reverse diode dv/dt <sup>d</sup>		•	dv/dt	17	- V/ns
Soldering recommendations (peak temperature	e) <sup>c</sup>	For 10 s		260	°C
Mounting torque, M3 screw		•		0.6	Nm

## Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b.  $V_{DD}$  = 120 V, starting  $T_J$  = 25 °C, L = 28.2 mH,  $R_g$  = 25  $\Omega$ ,  $I_{AS}$  = 0.8 A
- c. 1.6 mm from case
- d.  $I_{SD} \le I_D$ , di/dt = 100 A/ $\mu$ s, starting  $T_J$  = 25 °C
- e. Limited by maximum junction temperature



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THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	65	°C/W
Maximum junction-to-case (drain)	$R_{thJC}$	-	4.3	C/VV

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static					•		
Drain-source breakdown voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.73	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = 250 μA	3.0	-	5.0	V
Onto anima lankana	_	,	$V_{GS} = \pm 20 \text{ V}$	-	-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μΑ
7		V <sub>DS</sub> =	$V_{DS} = 600 \text{ V}, V_{GS} = 0 \text{ V}$		-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V	I <sub>D</sub> = 2.0 A	-	0.60	0.70	Ω
Forward transconductance a	9 <sub>fs</sub>	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 2.0 A		-	1.2	-	S
Dynamic		•					
Input capacitance	C <sub>iss</sub>	$V_{GS} = 0 V$ ,		-	347	-	pF
Output capacitance	C <sub>oss</sub>	Τ,	$V_{GS} = 0 \text{ V},$ $V_{DS} = 100 \text{ V},$		24	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1 MHz		-	4	-	
Effective output capacitance, energy related <sup>a</sup>	$C_{o(er)}$	V 0V 400V V 0V		-	17	-	
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>	V <sub>DS</sub> = 0 \	$V_{DS} = 0 \text{ V to } 480 \text{ V}, V_{GS} = 0 \text{ V}$		86	-	
Total gate charge	Qg			-	8	12	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 2.0 \text{ A}, V_{DS} = 480 \text{ V}$	-	3	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	3	-	
Turn-on delay time	t <sub>d(on)</sub>	V <sub>DD</sub> = 480 V, I <sub>D</sub> = 2.0 A,		-	12	24	
Rise time	t <sub>r</sub>			-	9	18	
Turn-off delay time	t <sub>d(off)</sub>	V <sub>GS</sub> =	$V_{GS} = 10 \text{ V}, R_g = 9.1 \Omega$		19	38	ns
Fall time	t <sub>f</sub>	7			22	44	
Gate input resistance	$R_g$	f = 1 MHz, open drain		1.1	2.3	4.6	Ω
Drain-Source Body Diode Characteristic	s						
Continuous source-drain diode current	I <sub>S</sub>	MOSFET symbol showing the integral reverse p - n junction diode		-	-	6.4	
Pulsed diode forward current	I <sub>SM</sub>			-	-	11	- A
Diode forward voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 2.0  \text{A},  V_{GS} = 0  \text{V}$		-	-	1.2	٧
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C, I <sub>F</sub> = I <sub>S</sub> = 2.0 A, di/dt = 100 A/ $\mu$ s, V <sub>R</sub> = 25 V		-	146	292	ns
Reverse recovery charge	Q <sub>rr</sub>			-	1.0	2.0	μC
Reverse recovery current	I <sub>RRM</sub>			-	13	-	A

### Notes

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

b.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

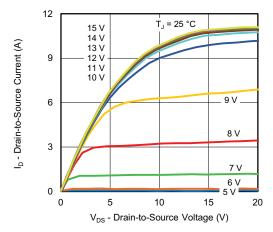


Fig. 1 - Typical Output Characteristics

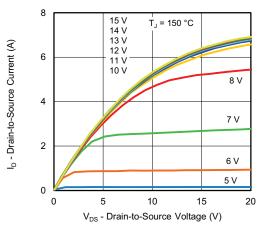


Fig. 2 - Typical Output Characteristics

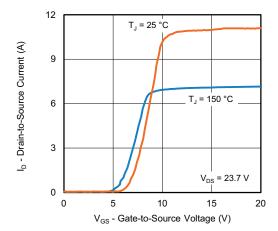


Fig. 3 - Typical Transfer Characteristics

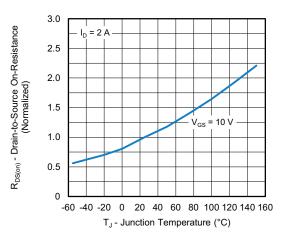


Fig. 4 - Normalized On-Resistance vs. Temperature

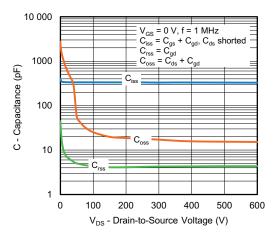


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

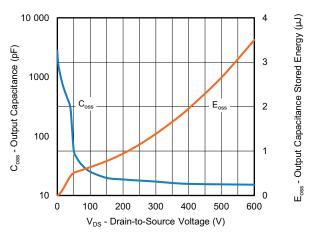


Fig. 6 - Coss and Eoss vs. VDS



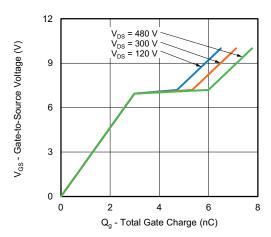


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

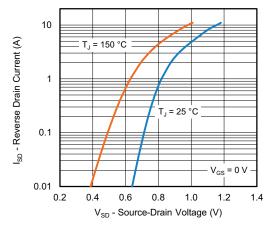


Fig. 8 - Typical Source-Drain Diode Forward Voltage

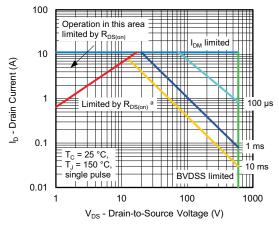


Fig. 9 - Maximum Safe Operating Area

#### Note

a.  $V_{GS} > minimum V_{GS}$  at which  $R_{DS(on)}$  is specified

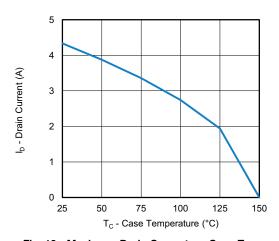


Fig. 10 - Maximum Drain Current vs. Case Temperature

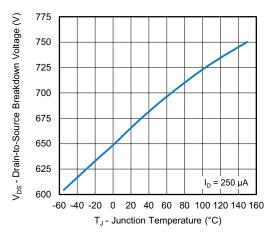


Fig. 11 - Temperature vs. Drain-to-Source Voltage



Normalized Effective Transient Thermal Impedance

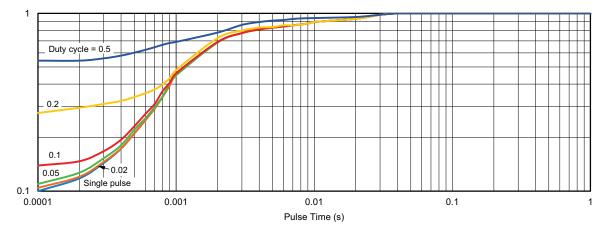


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

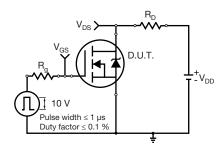


Fig. 13 - Switching Time Test Circuit

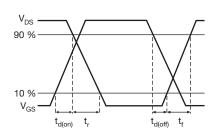


Fig. 14 - Switching Time Waveforms

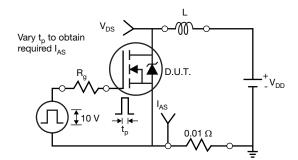


Fig. 15 - Unclamped Inductive Test Circuit

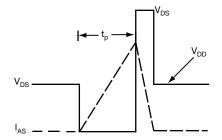


Fig. 16 - Unclamped Inductive Waveforms

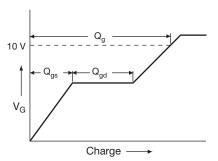


Fig. 17 - Basic Gate Charge Waveform

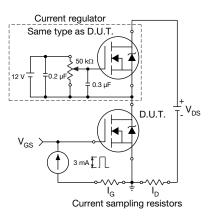
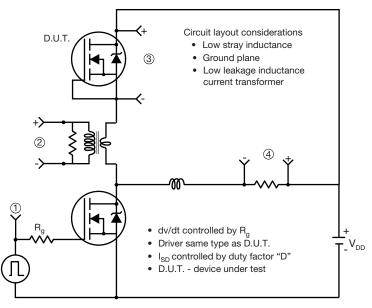


Fig. 18 - Gate Charge Test Circuit



## Peak Diode Recovery dv/dt Test Circuit



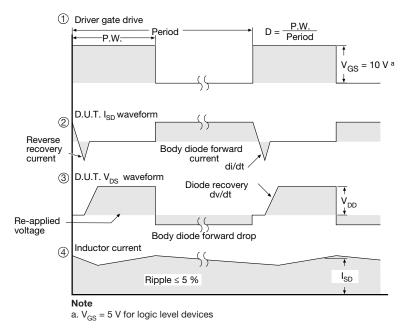


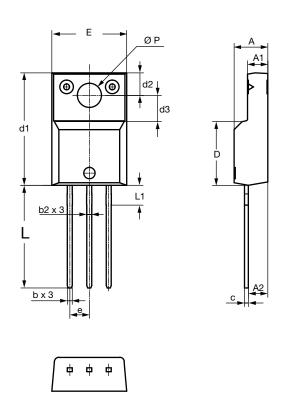
Fig. 19 - For N-Channel

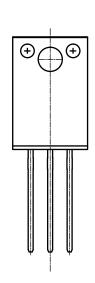
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# **TO-220 FULLPAK Thin Lead**





SYMBOL	DIMENSIONS				
	MILLIN	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.30	4.70	0.169	0.185	
A1	2.50	2.90	0.098	0.114	
A2	2.40	2.80	0.094	0.110	
b	0.60	0.80	0.024	0.031	
b2	0.60	0.90	0.024	0.035	
С	=	0.60	-	0.024	
D	8.30	8.70	0.327	0.342	
d1	14.70	15.30	0.579	0.602	
d2	2.90	3.10	0.114	0.122	
d3	3.30	3.70	0.130	0.146	
Е	9.70	10.30	0.382	0.406	
е	2.50	2.70	0.098	0.106	
L	13.40	13.80	0.528	0.543	
L1	1.00	2.80	0.039	0.110	
ØP	3.00	3.40	0.118	0.134	

ECN: E20-0684-Rev. D, 28-Dec-2020

DWG: 6021



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Vishay

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